Design Guide: TIDA-050026-23882 24-Port (2 pair) Power Sourcing Equipment Reference Design for Multi-port Applications

TEXAS INSTRUMENTS

Description

This reference design features an evaluation module for the 24-port (2 pair) PSE system which contains a hardware kit, a system firmware image, and a system firmware GUI. The hardware kit consists of a mother board (PSEMTHR24EVM-081), an MSP430 daughter card (PSEMCUDAUEVM-082), and a PSE daughter card (TPS23882EVM-084). To evaluate the system (both hardware and software), USB2ANY and MSP-FET adapters are also needed.

The MSP430F5234 on PSEMCUDAUEVM-082 has been programmed with pre-production firmware for EVM testing purposes. Please follow the instructions in this user's guide to flash the latest firmware from TI.com before evaluation.

Resources

TIDA-050026-23882 TPS23882EVM-084 PSEMTHR24EVM-081 PSEMCUDAUEVM-082 TPS23882 MSP430F5234 CSD19538Q3A Design Folder Tool Folder Tool Folder Tool Folder Product Folder Product Folder Product Folder



Search Our E2E[™] support forums

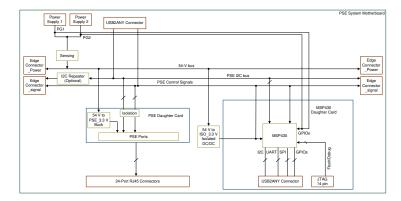
Features

- Onboard power monitoring
- 24 (2 pair) port system, and expandable to 48 port system
- Highly flexible system with configurable GUI and selectable host interface (I²C or UART)
- Multiport power management
- Multiple power supplies
- Supports legacy powered devices (PDs)

Applications

- Campus and branch switches
- Video recorder
- Edge router







An IMPORTANT NOTICE at the end of this TI reference design addresses authorized use, intellectual property matters and other important disclaimers and information.



System Description

1 System Description

This reference design provides a competitive and alternative solution.

In a multiport PSE system, the system-level software is the biggest challenge. The software handles complicated situations and addresses the following challenges:

- The power supply is usually not able to support all ports with a full load due to size and cost constraints. The system software manages the port power with priority to keep the total power consumption below the power budget.
- There are multiple power supplies in the system. These power supplies could be in sharing mode or backup mode. The system software shuts down low-priority ports fast enough to keep the total power consumption below the remaining power budget.
- There are some legacy PD devices that do not present the standard PoE PD signature. The system software finds a way to supply power to these devices.
- System software limits the port power based on the PD class levels or host configuration.
- When there are load-step changes on multiple ports, the system software acts quickly enough to keep the power consumption below the power budget.

DETAILS PARAMETER SPECIFICATIONS Input voltage 44 V-57 V 2 W-60 W Port power limit > 30 W is considered as nonstandard power Compliance IEEE 802.3bt Type 3 PD class level supported Class 0 to class 4 Number of power supply supported 1 - 2In sharing mode and redundant mode Max port number supported 48 Referred to RJ45 ports

1.1 Key System Specifications

Table 1. K	ey System	Specifications
------------	-----------	----------------

1.2 Description

This reference design features the TPS23882 daughtercard, the octal channel, the TPS23882 device, and the IEEE802.3bt ready PoE PSE controller. When paired with the PSE motherboard PSEMTHR24-081 (sold separately) and MCU daughtercard PSEMCUDAUEVM-082 (sold separately), users can evaluate the TPS23882 device and PSE system firmware solution.

The full PoE evaluation ecosystem includes the following:

- PSEMTHR24EVM-081: motherboard for 24-port PoE PSE applications (sold separately)
- PSEMCUDAUEVM-082: MSP430 daughtercard for 24-port PoE PSE applications (sold separately)
- TPS23882EVM-084: TPS23882 daughtercard for 24 port Type 3 (2 pair) PSE PoE PSE applications (sold separately)
- USB2ANY interface adapter: used with PSE system firmware GUI for I²C/UART interaction with the PSEMCUDAU-082 daughtercard (sold separately)
- MSP-FET programmer: used with Uniflash GUI for programming the MSP430 device
- PSE system firmware code image (request access to the code image through TIDA-050026-23882 folder or PSEMCUDAUEVM-082 tool folder)
- PSE system firmware GUI (request access to the code image through TIDA-050026-23882 folder or PSEMCUDAUEVM-082 tool folder)
 - **NOTE:** The MSP430F5234 on PSEMCUDAUEVM-082 has been programmed with pre-production firmware for EVM testing purposes. Please follow the instructions in this user's guide to flash the latest firmware from TIDA-050026-23882 folder or PSEMCUDAUEVM-082 tool folder before evaluation.



2 System Overview

2.1 Block Diagram

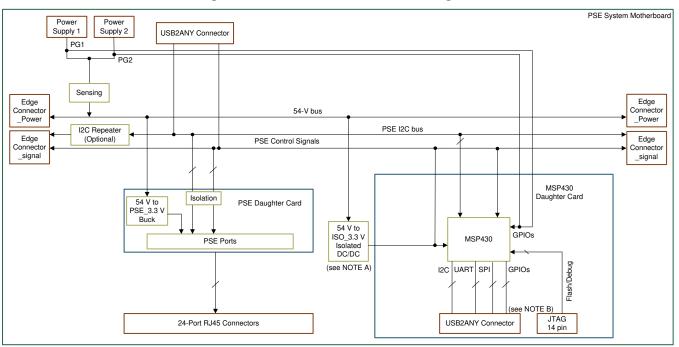


Figure 1. TIDA-050026-23882 Block Diagram

- A The 54-V to 3.3-V isolated DC/DC is for demonstration purposes only. It is not needed in a real system.
- B Only connect a USB2ANY connector or JTAG to avoid GND loops.

2.2 Design Considerations

2.2.1 Input Power

2.2.1.1 Vpwr

DC input voltage is provided through J1 and J3. This board supports a dual power source in sharing mode and redundant mode. If the power supplies are in redundant mode, make sure the main power supply is connected to J1 and a backup power supply is connected to the J3 connector.

The minimum PSE port voltage is 44 VDC for Type 1, 50 V for Type 2 and Type 3, and 52 V for Type 4. The maximum DC voltage at VPWR is 57 V for all types. During evaluation, choose the appropriate DC power supply for the different type environment.

2.2.1.2 3.3 V

A local 3.3 V for local devices (labeled as 3.3 V) is provided by the onboard LM5017 buck converter. The LM5017 device provides a basic power-on sequence and provides a well-controlled and consistent startup to prevent erratic operation. In addition to 44 V to 57 V, the TPS238x requires 3.3 V for the digital circuitry and each TPS2388x device consumes 6-mA typical and 12-mA maximum.

2.2.1.3 3.3 V_ISO

The reference design kit provides galvanic isolation between PoE power side and host side using digital isolators. The host side power is provided by 3.3 V_ISO.

2.2.2 Communication Interface

2.2.2.1 PSE fC Communication

The board provides two I²C interfaces communicating to PSE:

- 1. J10 on the motherboard (PSEMTHR24EVM-081) provides I²C access to all PSE devices directly. The TPS2388x GUI can communicate to PSE devices with the USB2ANY interface adapter.
- J11 and J12 on the motherboard (PSEMTHR24EVM-081) provides I²C access and system control signal to the MSP430 daughtercard.

2.2.2.2 MCU - Host Communication

The MSP430 daughtercard provides I²C/UART communication port to host through J12 to J14 on MSP430 daughtercard (PSEMCUDAUEVM-082). The PSE system GUI provides host configurations to the PSE system.

Host interface user's guide can be accessed from TIDA-050026-23882 folder or PSEMCUDAUEVM-082 tool folder.

2.2.3 MSP430F523x Hardware Design

PIN NUMBER MSP430F5234 (48RGZ)	TERMINAL	FUNCTION	COMMENT
COMMUNICATION	•		•
22	P3.0	I ² C SDA USCI_B0	I ² C to PSEs
23	P3.1	I ² C SCL USCI_B0	I ² C to PSEs
30	P4.1	I ² C SDA USCI_B1	I ² C to host
31	P4.2	I ² C SCL USCI_B1	I ² C to host
33	P4.4	UART TX USCI_A1	UART to host (debug only)
34	P4.5	UART RX USCI_A1	UART to host (debug only)
21	P2.7	SPI CLK USCI_A0	SPI to host (reserved)
24	P3.2	SPI slave TX enable, USCI_A0	SPI to host (reserved)
25	P3.3	UART TX,USCI_A0 or SPI slave in, master out	UART to host TX or SPI to host (reserved)
26	P3.4	UART RX, USCI_A0 or SPI slave out, master in	UART to host RX or SPI to host (reserved)
HARDWARE INTERRUPT	1L		-
13	P1.0	PSE INT	Connect to PSE INT pin
16	P1.3	OC Alert	Connect to external current sensing circuit if not used, connect to 3.3 V
18	P1.5	Power supply 1	Connect to power supply 1 power good signal. In RPS mode, P1.5 must be connected to main power supply. If there's only one power supply, the power good signal must be connected to P1.5.
19	P1.6	Power supply 2	Connect to power supply 2 power good signal, if not used, connect to GND. In RPS mode, P1.6 must be connected to backup power supply
20	P1.7	Disable all ports	This is for hardware disable ports(Reserved)
GENERAL I/O	•		•
4	P5.0	RESET	PSE RESET Connect to PSE RESET pin
17	P1.4	OSS	PSE OSS Connect to PSE OSS pin
46	P6.0	Interrupt pin to host	
35	P4.6	BSL mode indication to host	MCU configures as output. If MCU is in BSL mode, output high. If in normal operation mode, output low.
48	P6.2	Guard-band indication	Need an external LED

Table 2. MSP430 GPIO Pin Assignment

4 24-Port (2 pair) Power Sourcing Equipment Reference Design for Multi-port Applications

		-	· · · ·
PIN NUMBER MSP430F5234 (48RGZ)	TERMINAL	FUNCTION	COMMENT
47	P6.1	Selection between I ² C and SPI/UART	(Need to pullup or pulldown)
PROGRAM DOWNLOAD A	ND DEBUG	•	
44	PJ.3	ТСК	JTAG clock input
43	PJ.2	TMS	JTAG state control
42	PJ.1	TDI/TCLK	JTAG data input, TCLK input
41	PJ.0	TDO	JTAG data output
40		TEST/SBWTCK	Enable JTAG pins
45		RSTDVCC/SBWTDIO	External reset
EXTERNAL CRYSTAL			
7	P5.4	XTIN	External low frequency clock (use if needed)
8	P5.5	XTOUT	External low frequency clock (use if needed)

Table 2. MSP430 GPIO Pin Assignment (continued)

Pre-configure the host interface protocol through hardware as Table 3 shows.

Table 3. Host Interface Protocol

	P6.1	CS(P3.2)
l ² C	high	Don't care
UART	low	low
SPI (Reserved)	low	high

2.3 Highlighted Products

2.3.1 TPS23882

The TPS2388x device is the main IC to handle PoE functions to deliver power to PDs through Ethernet cable.

The TPS23882 is an 8-channel power sourcing equipment (PSE) controller engineered to insert power onto Ethernet cables in accordance with the IEEE 802.3bt standard. The PSE controller can detect powered devices (PDs) that have a valid signature, determine the power requirements of the devices according to their classification, and apply power. The TPS23882 improves on the TPS2388 with reduced current sense resistors, selectable Autonomous operation, SRAM programmability, programmable power limiting, capacitance measurement, and compatibility with TI's FirmPSE system firmware (see Device Comparison Table). Dedicated per port ADCs provide continuous port current monitoring and the ability to perform parallel classification measurements for faster port turn on times. A 1.25A port current limit and adjustable power limiting allows for the support of non-standard applications above 60W sourced. The 200 m Ω current sense resistor and external FET architecture allow designs to balance size, efficiency, thermal, and solution cost requirements. Port remapping and pin-to-pin compatibility with the TPS2388/80/81 devices eases migration from previous generation PSE designs and enables interchangeable 2-layer PCB designs to accommodate different system PoE power configurations.

2.3.2 MSP430F523x

The TI MSP family of ultra-low-power microcontrollers consists of several devices featuring different sets of peripherals targeted for various applications. The architecture, combined with extensive low-power modes, is optimized to achieve extended battery life in portable measurement applications. The device features a powerful 16-bit RISC CPU, 16-bit registers, and constant generators that contribute to maximum code efficiency. The digitally controlled oscillator (DCO) allows the device to wake up from lowpower modes to active mode in 3.5 μ s (typical). The MSP430F524x series are microcontroller configurations with four 16-bit timers, a high-performance 10-bit ADC, two USCIs, a hardware multiplier, DMA, a comparator, and an RTC module with alarm capabilities. The MSP430F523x series microcontrollers include all of the peripherals of the MSP430F524x series except for the ADC.

MSP430F523x is the main controller to control PSE devices(TPS2388x) through the I²C bus and also communicates to host CPU through I²C or UART to receive configurations and report system status.

2.3.3 ISO7741

The ISO7741 isolator is used to isolate I²C signals between PSE devices and the MCU.

The ISO774x devices are high-performance, quadchannel digital isolators with 5000 VRMS (DW package) and 3000 VRMS (DBQ package) isolation ratings per UL 1577. This family of devices has reinforced insulation ratings according to VDE, CSA, TUV and CQC. The ISO774x devices provide high electromagnetic immunity and low emissions at low power consumption, while isolating CMOS or LVCMOS digital I/Os. Each isolation channel has a logic input and output buffer separated by a double capacitive silicon dioxide (SiO2) insulation barrier. This device comes with enable pins which can be used to put the respective outputs in high impedance for multi-master driving applications and to reduce power consumption. The ISO7740 device has all four channels in the same direction, the ISO7741 device has three forward and one reverse-direction channels, and the ISO7742 device has two forward and two reverse-direction channels. If the input power or signal is lost, default output is high for devices without suffix F and low for devices with suffix F.

2.3.4 ISO7731

The ISO7731 digital isolator is used to isolate control signals (OSS, RESET, INT) between MSP430 and PSE devices.

The ISO773x devices are high-performance, triple channel digital isolators with 5000 VRMS (DW package) and 3000 VRMS (DBQ package) isolation ratings per UL 1577.

This family of devices has reinforced insulation ratings according to VDE, CSA, TUV, and CQC.

The ISO773x family of devices provides high electromagnetic immunity and low emissions at low power consumption, while isolating CMOS or LVCMOS digital I/Os. Each isolation channel has a logic input and output buffer separated by a silicon dioxide (SiO2) insulation barrier. This device comes with enable pins which can be used to put the respective outputs in high impedance for multi-master driving applications and to reduce power consumption. The ISO7730 device has all three channels in the same direction and the ISO7731 device has two forward and one reverse-direction channel. If the input power or signal is lost, the default output is high for devices without suffix F and low for devices with suffix F. See the device *Functional Modes* section for further details.

Used in conjunction with isolated power supplies, this device helps prevent noise currents on a data bus or other circuits from entering the local ground and interfering with or damaging sensitive circuitry. Through innovative chip design and layout techniques, electromagnetic compatibility of the ISO773x device has been significantly enhanced to ease system-level ESD, EFT, surge, and emissions compliance.

2.3.5 CSD19538

6

This 100-V, 49-m Ω , SON 3.3-mm × 3.3-mm NexFETTM power MOSFET is designed to minimize conduction losses and reduce the board footprint in PoE applications.



2.3.6 LM5017

The LM5017 device is used to generate 3.3 V to supply PSE devices.

The LM5017 is a 100-V, 600-mA synchronous step-down regulator with integrated high-side and low-side MOSFETs. The constant on-time (COT) control scheme employed in the LM5017 device requires no loop compensation, provides excellent transient response, and enables very high step-down ratios. The on-time varies inversely with the input voltage resulting in nearly constant frequency over the input voltage range. A high-voltage startup regulator provides bias power for internal operation of the IC and for integrated gate drivers. A peak current limit circuit protects against overload conditions. The undervoltage lockout (UVLO) circuit allows the input undervoltage threshold and hysteresis to be independently programmed. Other protection features include thermal shutdown and bias supply undervoltage lockout (VCC UVLO).

2.3.7 LM5020

The LM5020 device is used to generate isolated LM5020 to supply MSP430 and isolators.

The LM5020 high-voltage pulse-width modulation (PWM) controller contains all of the features needed to implement single-ended primary power converter topologies. Output voltage regulation is based on current-mode control, which eases the design of loop compensation while providing inherent line feed-forward. The LM5020 device includes a high-voltage start-up regulator that operates over a wide-input range up to 100 V. The PWM controller is designed for high-speed capability including an oscillator frequency range to 1 MHz and total propagation delays less than 100 ns. Additional features include an error amplifier, precision reference, line undervoltage lockout, cycle-by-cycle current limit, slope compensation, softstart, oscillator synchronization capability and thermal shutdown.

2.3.8 LM5050

The LM5050 device is used to support 2 power supplies in the system to work in backup mode.

The LM5050-1 and LM5050-1-Q1 high-side ORing FET controller operates in conjunction with an external MOSFET as an ideal diode rectifier when connected in series with a power source. This ORing controller allows MOSFETs to replace diode rectifiers in power distribution networks thus reducing both power loss and voltage drops.

The LM5050-1 and LM5050-1-Q1 controllers provide charge pump MOSFET gate drive for an external Nchannel MOSFET and a fast response comparator to turn off the FET when current flows in the reverse direction. The LM5050-1 and LM5050-1-Q1 can connect power supplies ranging from 5 V to 75 V and can withstand transients up to 100 V.

2.3.9 INA240

The INA240 amplifier is used to measure the total current from the input to support fast shutdown in an event of load step change.

The INA240 device is a voltage-output, current-sense amplifier with enhanced PWM rejection that can sense drops across shunt resistors over a wide common-mode voltage range from -4 V to 80 V, independent of the supply voltage. The negative common-mode voltage allows the device to operate below ground, accommodating the flyback period of typical solenoid applications. Enhanced PWM rejection provides high levels of suppression for large common-mode transients (Δ V/ Δ t) in systems that use PWM signals (such as motor drives and solenoid control systems). This feature allows for accurate current measurements without large transients and associated recovery ripple on the output voltage. This device operates from a single 2.7-V to 5.5-V power supply, drawing a maximum of 2.4 mA of supply current. Four fixed gains are available: 20 V/V, 50 V/V, 100 V/V, and 200 V/V. The low offset of the zero-drift architecture enables current sensing with maximum drops across the shunt as low as 10-mV full-scale.



2.3.10 REF3425

The REF3425 device is used to provide a threshold to output the INA240 and generate a signal to MCU for overcurrent alert.

The REF34xx device is a low temperature drift (6 ppm/°C), low-power, high-precision CMOS voltage reference, featuring ±0.05% initial accuracy, low operating current with power consumption less than 95 μ A. This device also offers very low output noise of 3.8 μ Vp-p /V, which enables its ability to maintain high signal integrity with high-resolution data converters in noise critical systems. With a small SOT-23 package, the REF34xx offers enhanced specifications and pin-to-pin replacement for MAX607x and ADR34xx. The REF34xx family is compatible to most of the ADC and DAC such as the ADS1287, ADUCM360, and ADS1112 devices. Stability and system reliability are further improved by the low output-voltage hysteresis of the device and low long-term output voltage drift. Furthermore, the small size and low operating current of the devices (95 μ A) can benefit portable and battery-powered applications.

2.3.11 TPS3890

The TPS3890 device is used to monitor the existence of the power supply and generate power good signal to MCU. The MCU can adjust the total power budget of the system.

The TPS3890 device is a precision voltage supervisor with low-quiescent current that monitors system voltages as low as 1.15 V, asserting an open-drain RESET signal when the SENSE voltage drops below a preset threshold or when the manual reset (MR) pin drops to a logic low. The RESET output remains low for the user-adjustable delay time after the SENSE voltage and manual reset (MR) return above the respective thresholds. The TPS3890 family uses a precision reference to achieve 1% threshold accuracy. The reset delay time can be user-adjusted between 40 μ s and 30 s by connecting the CT pin to an external capacitor. The TPS3890 device has a very low quiescent current of 2.1 μ A and is available in a small 1.5-mm x 1.5-mm package, making the device well-suited for battery-powered and space-constrained applications.

3 Hardware, Software, Testing Requirement and Test Result

3.1 Required Hardware and Software

3.1.1 Hardware

The following hardware is required to get started with the reference design:

- PSEMTHR24EVM-081: motherboard for 24 port PoE PSE applications (sold separately)
- PSEMCUDAUEVM-082: MSP430 daughtercard for 24 Port PoE PSE applications (sold separately)
- TPS23882EVM-084: TPS23882 daughtercard for 24-port Type 3 (2 pair) PoE PSE applications (sold separately)
- USB2ANY interface adapater: used with PSE system firmware GUI for I²C/UART interaction with PSEMCUDAU-082 daughtercard (sold separately)
- MSP-FET programmer: used with the Uniflash GUI for programming the MSP430 device

3.1.2 Software

- FirmPSE code image (request access to the code image through the TIDA-050026-23882 folder or the PSEMCUDAUEVM-082 tool folder)
- FirmPSE GUI (request access to the GUI through the TIDA-050026-23882 folder or the PSEMCUDAUEVM-082 tool folder)



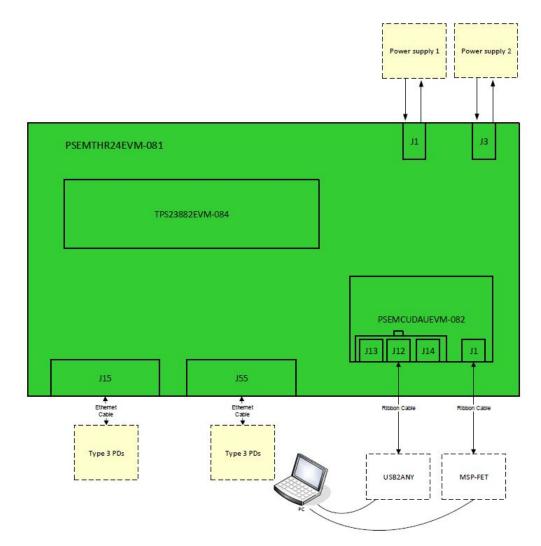
3.2 Testing and Results

3.2.1 Test Setup

3.2.1.1 Hardware Setup

Figure 2 shows the hardware test setup of the ecosystem.







3.2.1.2 LED, Test Point, Jumper and Connector Settings

3.2.1.2.1 EVM LEDs

Table 4 lists the EVM LEDs and their descriptions.

Table 4. EVM LEDs

LED	COLOR	DESCRIPTION
PSEMTHR24EVM-081		
J15, J55	Green, Yellow	There is one green and yellow LED on each RJ45 port
PSEMCUDAUEVM-082		
D1	Green	The total power consumption is within the pre-configured guardband

3.2.1.2.2 EVM Test Points

Table 5 lists the EVM test points.

ТР	LABEL	DESCRIPTION
PSEMTHR24EVM-081	•	
TP1	55VDC	VPWR
TP2	GND	VPWR ground
TP3	OC-ALERT	System over current alert signal
TP4	SDA	I ² C data
TP5	SCL	I ² C clock
TP6	PG1	Power good signal for power supply #1
TP7	PG2	Power good signal for power supply #2
TP8	PSE_3.3V	3.3 V for PSE devices
TP9	GND	PSE_3.3V ground
TP10	3.3V_ISO	Isolated 3.3V for MSP430
TP11	3.3V	3.3 V for debug
TPS12, TP13	GND_ISO	3.3V_ISO ground
TP14	OSS	OSS signal from MCU to PSE
TPS23882EM-084	L	
TP1	PSE_3.3	3.3 V for PSE devices
TP2	VPWR	VPWR for PSE devices
TP3, TP4, TP14, TP19	GND	VPWR and PSE_3.3V ground
TP5	3.3V_ISO	Isolated 3.3 V
TP6	RESET	Reset signal from MCU
TP7	OSS	OSS signal from MCU
TP8	INT	INT signal to MCU
TP9	SDA	I ² C data from/to MCU
TP10	SCL	I ² C clock from MCU
TP11	PSE_RST	Reset signal to PSE
TP12	PSE_OSS	OSS signal to PSE
TP13	PSE_INT	INT signal from PSE
TP15	GND_ISO	3.3V_ISO ground
TP16	PSE_SCL	I ² C clock signal to PSE
TP17	PSE_SDAI	I ² C data to PSE
TP18	PSE_SDAO	I ² C data from PSE

Table 5. EVM Test Points

Hardware, Software, Testing Requirement and Test Result

3.2.1.2.3 EVM Jumpers

Table 6 lists the EVM test jumpers and their descriptions.

JUMPER	DEFAULT PIN POSITION	DESCRIPTION
PSEMTHR24EVM-081		
J13	1-2	3.3 V comes from PSE daughtercard
J14	1-2	Connect 3.3V_ISO to supply the circuit
J17, J22, J38, J43, J19, J23, J32, J28, J52, J47, J31, J26	1-2	Enable port LED
J45, J42, J24, J21, J44, J49, J53, J30, J33, J51, J54	1-2	Enable port LED
J57, J62, J78, J83, J59, J63, J72, J68, J92, J87, J71, J66	1-2	Enable port LED
J85, J82, J64, J61, J84, J80, J89, J93, J70, J91, J94	1-2	Enable port LED
TPS23882EVM-084		
J3	1-2, 3-4	PSE devices' address configuration

Table 6. EVM Test Jumpers

3.2.1.2.4 EVM Input and Output Connectors

Table 7 lists the EVM input and output connectors.

Table 7. EVM Input and Output Connectors

CONNECTOR	DESCRIPTION
PSEMTHR24EVM-081	
J1, J3	DC power supply input (44-57 V VDC, 41 A)
J2, J4, J6, J7	Edge connector for DC bus when connecting 2 boards together
J5	Power to PSE daughtercard
J8, J9	Edge connector for PSE signals (I ² C, OSS, RESET and INT) when connecting 2 boards together
J10	Connector to USB2ANY for direct I ² C access to PSE devices(for debug purpose only)
J11	Connectors to PSE daughter for PSE signals (I ² C, OSS, RESET and INT)
J12	Connectors to MSP430 daughter for PSE signals (I ² C, OSS, RESET and INT), system level signals (OC-ALERT, PG) and isolated 3.3 V
J15, J55	PSE ports magjacks
J34, J35, J36, J74, J75, J76	PSE port connector to PSE daughter card
J95, J96	For MSP430 daughter card mechanical mounting purpose
TPS23882EM-084	
J1	Pair with J5 on motherboard
J4	Pair with J11 on motherboard
J5	Pair with J34, J35, J36, J74, J75, J76 on motherboard
PSEMCUDAUEVM-082	
J1	JTAG connector
J3, J7, J8, J9	Extended GPIO access
J11	Pair with J12 on motherboard
J12, J13, J14	USB2ANY connector (30 pin)
J17, J18	For MSP430 daughter card mechanical mouting purpose



3.2.1.3 System Firmware GUI Setup

3.2.1.3.1 PSE System Firmware GUI Installation

TI's PSE system firmware GUI is used with the PSE system EVM kit (PSEMTHR24EVM-081, PSEMCUDAUEVM-082, TPS23882EVM-084) to configure the system, generate the code image and flash to MSP430 device. Download the PSE system firmware GUI from TIDA-050026-23882 folder or PSEMCUDAUEVM-082 tool folder.

3.2.1.3.2 PSE System Firmware GUI Operation

Start the PSE system firmware GUI by double clicking the GUI icon and clicking the Start button. A window similar to Figure 3 appears. The Offline mode is selected by default.

PSE	System Firmware GUI	File	Options	Tools	Help										×
≡ M	enu														
#	Firmware Configuration				Mo	ONLINE	OFFLINE	0	Load	• 0	Configure	(Review	& Gener	ate
				MSP430 Firm	nware Platform	MSP430F52	34	•							
۹															
ß															
						~									
						0									
					Dr	ag & Dro	р								
				or browse f	or the comple	ete hex file config	with image cod	de here							
						Browse									
	0														
	0														
	Help												Powered By O		
🗐 ශ	US82ANY/OneDemo device Har	tware Conne	cted.									TE:	xas Insti	RUMEN	NTS

Figure 3. GUI Startup

Select the MSP430 device you want to start with and then load the PSE system firmware code image (access from TIDA-050026-23882 folder or PSEMCUDAUEVM-082 tool folder). When finished, click *Proceed* to go to the configuration page.

PSE	System Firmware GUI	File Options Tools Help	0	×
≡ м	enu			
*	Firmware Configuration	Mode	ONLINE OFFLINE 1 Load (2) Configure (3) Review & Gen	erate
		MSP430 Firmware Pla	atform: MSP430F5234	
۵		Hex File Upload: The firmware hex file matche	es the MSP430F5234 firmware schemal	
ß		PSE_Manager.txt	Remove	
		Firmware Verification	¥	
		Load Default S/M Configuration	¥	
		Load PPM Configuration	~	
		Load PSE System Firm * Load PSE System Firmware image only for imported project.	Ware Image - Browse In other cases, load her file directly from Her File Upload sector.	
	0	Change PSE SRAM code - Browse		
	Help	Change PSE SRAM Parity code - Browse	Powered By GUI Com	10036774
<i>]</i> e	USB2ANY/OneDemo device Har	dware Connected.	🔱 Texas Instrume	

Figure 4. GUI Device Selection and Image Load

The configurations are split into four sections: system configuration, PPM (Port Power Management) configuration, device configuration, and port configuration.

The system configuration is applied to the whole system. This tab is always available on the to the right of the GUI. The following parameters can be configured through the system configuration tab:

Legacy detection functions

Legacy devices released prior to the PoE standard can be powered through the Ethernet cable. The PSE system firmware detects these legacy PDs and powers on with protection.

• Use of external sensing circuit

The external sensing circuit is used to measure the total power consumption of the system. When the current exceeds the power budget, the MCU shuts down low priority ports. This increases the system response to the load step change.

- System bootup setting
 - 1. Turn on the PSE port as soon as the power is up.
 - 2. Turn on the PSE port after the PoE enable command is sent from the host
- Port overload retry mode
 - 1. Re-enable immediately: after overload happens, the port is re-enabled immediately. If the overload still presents, it will try at most five times and shuts down the port if the overload is not removed within five retries. The port is re-enabled after the PD is removed from the port and reconnects to the port.
 - 2. Re-enable after PD is disconnected and connected: after overload happens, the port is disabled immediately and is re-enabled after the PD is removed from the port and reconnects to the port.
 - 3. Timer controlled: the port is re-enabled immediately after overload happens. The port keeps retrying for a period (controller by timer) and is disabled after the timer expires. The port is re-enabled after the PD is removed from the port and reconnects to the port.
- OSS signal source (from MCU or CPLD):In a multi-power supply system, when one power supply has
 faults and the remaining power supply is not able to supply the current power consumption, turn off low
 priority ports to protect the remaining power supply. The OSS function of the PSE is used to fast
 shutdown the low priority ports. There are 2 sources to generate the OSS signal:



- 1. MSP430 generates the OSS signal
- 2. CPLD generates the OSS signal
- Interrupt mask

The interrupt mask in Figure 5 can be configured to enable interrupt events to notify the host through the MSP430 P6.0.

Figure 5. GUI System Configuration and PPM Configuration

PSE	System Firmware GUI	le Options Tools Help		_ 🗆 ×
≡ м	enu			
#	Firmware Configuration Firmware	Platform: MSP430F5234 Version: E0000002 Mo	de ONLINE OFFLINE 1 Load ····	Configure 3 Review & Generate
=	PPM Config	e Config 🛛 Port Config		System Configuration
	Power Limit Mode	Power Policy	Multi Power Supply Mode	Legacy Enable 💿 💶
8	Class Based Limit	Dynamic •	Power supply in Back up Mod 🔹	Legacy Mode Power Value Capacitance
				EXT Sense Enable
	Total Power Supply Number	Power Supply 1 (Main) (Watt)	Power Supply 2 (Backup) (Watt)	E Turn On Immediately
	2	500 \$	400 \$	Retry Mode O
	Guard Band (mWatt)			Re-enable port in •
	30000 \$			OSS Source Total Ports O
				MCU GPIO Drive 24
				Interrupt Mask
				See SRAM Fault PSE TSD
				Se Supply Fault Port Tstart Fault
- 1	Reset to Default		Proceed	Port Overload Fault Port Short Circuit Fault
- 1				Port Communication Error Powered By GUI Composer
/ (;)	USB2ANY/OneDemo device Hardware	Connected.		de Texas Instrument

PPM configuration is applied to the port power management mechanism. The following parameters can be configured through the PPM configuration tab:

- Power limit mode:class limit mode and port limit mode
 - 1. Class limit mode:in class limit mode, the port power is limited by the PD's class level. For example, if the PD is class 8, the port power limit(PCUT) is set to 90W.
 - 2. Port limit mode:in port limit mode, the port power is limited by the host. The host should set port power limit before the port is powered on.
- Power policy: static and dynamic mode
 - 1. Static mode:in static mode, the port power allocation is set to port power limit. In class limit mode, port power allocation is class level power of the PD and in port limit mode, the port power allocation is the port power limit configured from the host.
 - 2. Dynamic mode: in dynamic mode, the port power allocation equals to the port's actual consumed power. It allocates the port's unused power to other ports.
- Multi-power supply mode: RPS and sharing mode:
 - Redundant power supply (RPS) mode:in RPS mode, the total power budget equals to main power supply's power budget when both main power supply and backup power supply are connected. The total power budget equals to backup power supply's power budget when the main power supply is disconnected.
 - 2. Sharing power supply mode:in sharing mode, the total power budget equals to the sum of two power supplies' power budget when both power supplies are connected. The total power budget equals to remaining power supply's power budget if one of the power supplies is disconnected.
- Total number of power supplies and the power budget of each power supply. If there's only one power supply, the power good signal must be connected to P1.5.



 Power guard band: when the total allocated power < total power budget — guard band, there's no more low priority ports to be turned on and the guard band LED will turn on.

Device configuration is mainly used to configure the mapping between the PSE device channels and the logical RJ45 ports. When mapping a 4-pair port, only channels within the same quad (channel 1–4 or channel 5–8) can be mapped to one 4-pair port.

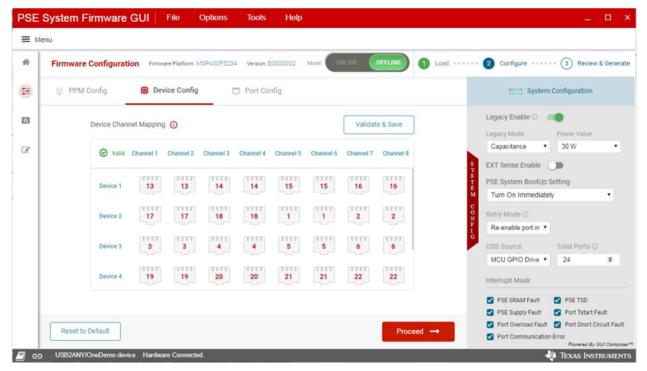


Figure 6. GUI Device Configuration

The *Port Configuration* is applied to the port by port settings, such as port PoE enable and disable, port priority, and port power limit (only in port limit mode).





Firmware Con	figuration F	irmware Platform: M	SP430F5234 Ve	ersion: E0000002 Mode:	ONLINE OFFLINE 1 Load	Configure	3 Review 8	& Gen
PPM Confi	9 🔲	Device Config	💭 Po	ort Config		(and System	Configuration	
RJ45 Port Config (Hold	Ctri and select mu	tiple ports to configu 4 9 14 19	se and apply same settings	Selected RJ45 Port - 11 Physical Channel : 12,13 Port Enable Priority High	Legacy Enable Legacy Mode Capacitance EXT Sense Enable PSE System BootUp Turn On Immediate Retry Mode Re-enable port in • OSS Source MCU GPIO Drive •	Setting	•
21	22	23	24			Interrupt Mask		

When everything has been configured, click the *Proceed* button. The summary page displays all of the configurations being set compared to the factory default configurations. When everything is verified, you can generate the hex file or flash the code to the MSP430 device directly.

Filliware	Configuration Firmware Pla	rtform: MSP430F5234 Ve	OFFLINE 1 Load	Configure	Review & Ger		
	System and PPM Configu	ration Summary					
-		System Configurat	ion	PPM Configuration			
Ţ	Config	Default	User		Config	Default	User
	Legacy Enable	ON			Power Limit Mode	Class Based Limit	Class Based Limit
	Legacy Mode	ON	Capacitance		Power Policy	Dynamic	Dynamic
	Power Value	30 W	30 W	•	Multi Power Supply Mode	Power supply in Back up Mode [RPS]	Power supply in Back up ?
				Review De	wice Config		

Figure 8. GUI Configuration Summary

When configurations are reviewed, the GUI can generate the default code image and program the device directly through **MSP-FET**.



Firmware	Configuration Firr	Import Project Versi Export Project	on: E0000002 Mode: ONLINE	OFFLINE 1 Load	Configure	Review & Ger
	System and PPM Co	onfiguration Summary				
-		System Configuration	i.		PPM Configuration	
Ċ	Config	Default	User	Config	Default	User
	Legacy Enable	ON		Power Limit Mode	Class Based Limit	Class Based Limit
	Legacy Mode	ON	Capacitance •	Power Policy	Dynamic	Dynamic
	Power Value	30 W	30 W	Multi Power Supply Mode	Power supply in Back up Mode [RPS]	Power supply in Back up t
			Review De	vice Config		

Figure 9. GUI Program Device and Generate Hex

When the code is successfully flashed to the MSP430, the system will be up and running. MSP-FET can be disconnected from the laptop or PC. Connect the USB2ANY (with 30-pin ribbon cable) to a laptop or PC and the GUI will be in online mode after selecting host interface protocol.

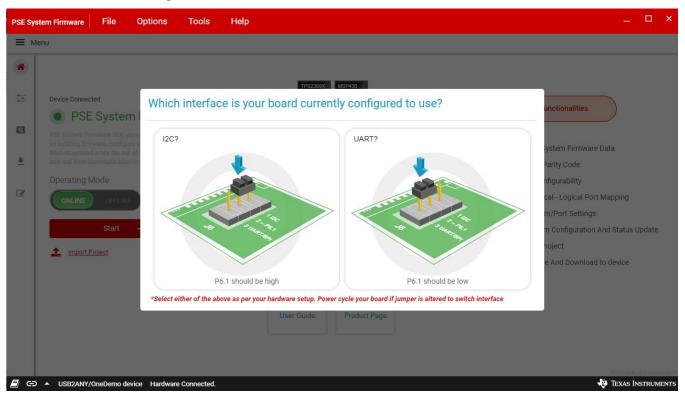


Figure 10. Host Interface Protocol Selection in Online Mode



When the device is connected to GUI, real-time changes can be made on the configuration page and status page shows the real time system status. The status page shows the system, device, and port real-time status. The user can also change the system configuration in the configuration page: each change is converted to a host command to the MSP430 MCU. The user can also press the *Save Configuration* button to save the current configuration as the default setting.

	System Statu	s									Auto Read S	Status : Read
R	3J45 Port Config 🛈)										
	1	2	3	4	5	6	7	8	Selected Port - 1	⑦ Port I2C A	ddress - 0x22 Physical Cha	annels - 12,1
									Port Status Port On/Off		Port Consumed Power	0 mW
	9	10	11	12	13	14	15	16	Detection Classification Port Faults	Open Circuit Unknown	Port Priority	High
									Overload Fault	•	Short Fault	٠
	17	18	19	20	21	22	23	24	Start Fault Port Fault Counter	•		
									Disconnect Counter Overload Counter Short Counter	0	Invalid Signature Counter Power Deny Counter	0
ſ	Device Faults					:	System Statu	s				
	SRAM Fault		VI Z	PUV/VDUV Fai	ult (Guard Band Ale	ert	 Input Voltage 	49 V	Total Allocated Power	7673 mW

Figure 11. GUI Status Page

The BSL firmware update page provides the field firmware upgrade functions that the firmware can be upgraded through the same I²C or UART port as the normal communication. This is beneficial to firmware upgrade after the product is released to customers.



Hardware, Software, Testing Requirement and Test Result

www.ti.com

File Options Tools Help PSE System Firmware 🔳 Menu 1 **BSL Firmware Update** (i) Upload the Firmware File and Click 'Update System Software' -٩ **±** () Please uncheck if you want to exclude any of the below two steps Enable BSL Mode(Step 1) Ø Verify Loaded Program(Step 5) Drag & Drop or browse for the complete hex file config with image code here Browse 5 Program Verified Entered BSL Password Mass Erase Firmware Mode Verified Done Load CO USB2ANY/OneDerno device Hardware Connected. 🐺 Texas Instruments

Figure 12. BSL Firmware Update Page

Before using BSL page to update the MSP430 firmware, BSL code needs to be flashed to MSP430 if it hasn't been flashed. Download Uniflash from ti.com and use it to flash the BSL code by following the steps:

Select MCU device to MSP430F5234.



Figure 13. MCU Device Selection Page

9 UniFlash		
UniFlash Session - About	? Help	Settings
✓ Detected Devices		
Detect My Device		
Connected devices will automatically appear here! [More Info]		
Start Now		
✓ New Configuration		
M5743095234		~ ×
Selected Device: MSP430F5234		
		~ ×
Selected Connection: 🝟 TI MSP430 USB1		
3 Start Edit		
Select a .coxml file to create a new session.		

Configure the flash section.

Figure 14. Configure Settings and Utilities Page

9 UniFlash			
UniFlash Session -	About	? Hel	o 🏟 Setting
Configured Device : TI MSP430 USI	31 > MSP430F5234 [more info] [download ccxml]		 MSP430
Program	Find and Configure Settings and Utilities		
Settings & Utilities	Q. Search: Enter Property ID Or Name To Search For Settings and Buttons	I≡ More Info	Pin Option
Memory	▼ Download		
Standalone Command Line	Target Voltage (mV): 3300 Allow Read/Write/Erase access to BSL memory Erase Options: Erase main memory only Erase main and information memory Erase main, information and protected information memory Erase and download necessary segments only (Differential Download) Replace written memory locations, retain unwritten memory locations By Address Range (specify below)		
	▼ Erase		
Console		≡ cl	ear X Close



Hardware, Software, Testing Requirement and Test Result

Load BSL code and flash to MSP430.

Figure 15	. Select a	and Load	Images	Page
-----------	------------	----------	--------	------

5 UniFlash		1		×
UniFlash Session -	About	? Help	🌻 Sett	tings
Configured Device : TI MSP430 USE	31 > MSP430F5234 [more info] [download ccxml]		• MSP	430
Program	Select and Load Images			-
Settings & Utilities	Flash Image(s)			
Memory	MSP430F522x_l2C.txt Size: 7	.75 KB Binary: 🗌) ×	
Standalone Command Line	\odot			
	Available Action(s) - 1 Image Selected Load Image Verify Image			
	Reset Actions [Click here to query available reset options]			
	Run Actions Run Target After Program Load/Flash Operation			
	▼ Quick Settings			•
Console		≓ Clear	×c	lose

In the debug page, user's can read and write raw data to MSP430 following host interface protocol and to each PSE device's registers by providing I²C address and register number. The password is "C430".



Design Files

Figure 16. Debug Page

PSE S	ystem Firmware File Option	s Tools Help		-		×
Ξ	Menu					
*	Debug					
- <u>t</u>			For Internal Purpose Only			
٩	PPM Enable					
<u>+</u>	PPM Enable		Enter the Password			
Ø	Mode READ WRITE		Password *****			
	I2C Address ©	Internal Address O	Proceed			
	0x 20	0x 12				
	Send					
				owered By GU		
<i>a</i>	D USB2ANY/OneDerno device Hard	lware Connected.		èxas Inst	RUMEN	TS

3.2.2 Test Results

The IEEE 802.3bt compliance test suite is currently not available. The test report will be added in the fourth quarter of 2019.

4 Design Files

4.1 Schematic

To download the schematics, see the design files at TIDA-050026-23882.

4.2 Bill of Materials

To download the bill of materials (BOM), see the design files at TIDA-050026-23882.

4.3 PCB Layout Recommendations

KSENSA is shared between SEN1 and SEN2, KSENSB is shared between SEN3 and SEN4, KSENSEC is shared between SEN5 and SEN6, KSENSED is shared between SEN7 and SEN8. To optimize the accuracy of the measurement, the PCB layout must be done carefully to minimize the impact of PCB trace resistance. Refer to the TPS23882 Layout section as an example.

4.3.1 Layout Prints

To download the layer plots, see the design files at TIDA-050026-23882.

4.4 Altium Project

To download the Altium project files, see the design files at TIDA-050026-23882.



4.5 Gerber Files

To download the Gerber files, see the design files at TIDA-050026-23882.

4.6 Assembly Drawings

To download the assembly drawings, see the design files at TIDA-050026-23882.

5 Software Files

To download the software files, see the design files at TIDA-050026-23882.

6 Related Documentation

- 1. Texas Instruments, TPS23882 High-Power, 8-Channel, Power-Over-Ethernet PSE With 200-mQ R_{SENSE}
- 2. Texas Instruments, TPS2388x PSE System Firmware Host Interface Protocol User's Guide

6.1 Trademarks

E2E, NexFET are trademarks of Texas Instruments. All other trademarks are the property of their respective owners.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated